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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR **2SJ649**

### **SWITCHING** P-CHANNEL POWER MOS FET

#### **DESCRIPTION**

The 2SJ649 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

#### ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ649	Isolated TO-220

#### **FEATURES**

· Low on-state resistance:

 $R_{DS(on)1} = 48 \text{ m}\Omega \text{ MAX}. \text{ (VGS} = -10 \text{ V}, I_D = -10 \text{ A)}$ 

 $R_{DS(on)2} = 75 \text{ m}\Omega$  MAX. (Vgs = -4.0 V, ID = -10 A) • Low input capacitance:

 $C_{iss} = 1900 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V})$ 

Built-in gate protection diode

(Isolated TO-220)

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Drain to Source Voltage (Vgs = 0 V)	Voss	-60	V	
Gate to Source Voltage (Vps = 0 V)	urce Voltage (Vps = 0 V) Vgss $\mp 20$			
Drain Current (DC) (Tc = 25°C)	$I_{D(DC)}$ $\mp 20$		Α	
Drain Current (pulse) Note1	D(pulse)	∓70	Α	
Total Power Dissipation (Tc = 25°C)	PT	25	W	
Total Power Dissipation (T <sub>A</sub> = 25°C)	Рт	2.0	W	
Channel Temperature	Tch	150	°C	
Storage Temperature	Tstg	-55 to +150	°C	
Single Avalanche Current Note2	rent Note2 IAS -20		Α	
Single Avalanche Energy Note2	Eas	40	mJ	

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = -20  $\rightarrow$  0 V



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#### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

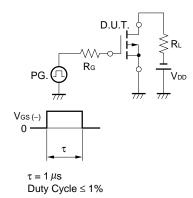
0,	0 1 1	T 10 W		T) (D	14434	
Characteristics	Symbol	Test Condtions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-10	μΑ
Gate Leakage Current	Igss	V <sub>G</sub> S = ∓20 V, V <sub>D</sub> S = 0 V			∓10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance Note	yfs	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -10 A	10	20		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = -10 V, ID = -10 A		38	48	$m\Omega$
	R <sub>DS(on)2</sub>	$V_{GS} = -4.0 \text{ V}, I_{D} = -10 \text{ A}$		47	75	$m\Omega$
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		1900		pF
Output Capacitance	Coss	V <sub>G</sub> S = 0 V		350		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		140		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = -30 V, I <sub>D</sub> = -10 A		10		ns
Rise Time	<b>t</b> r	Vgs = -10 V		10		ns
Turn-off Delay Time	td(off)	$R_G = 0 \Omega$		73		ns
Fall Time	<b>t</b> f			17		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -48 V		38		nC
Gate to Source Charge	Qgs	V <sub>GS</sub> = -10 V		7		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -20 A		10		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = 20 A, VGS = 0 V		0.95		V
Reverse Recovery Time	trr	IF = 20 A, Vgs = 0 V		49		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		100		nC

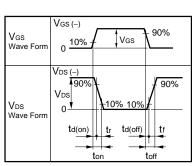
**Note** Pulsed: PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

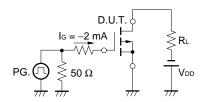
# $V_{GS} = -20 \rightarrow 0 \text{ V}$ $V_{DD}$ $V_{DD}$

#### **TEST CIRCUIT 2 SWITCHING TIME**

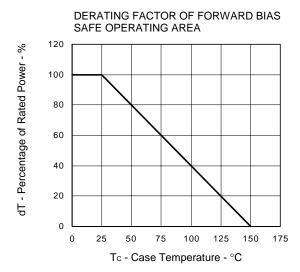


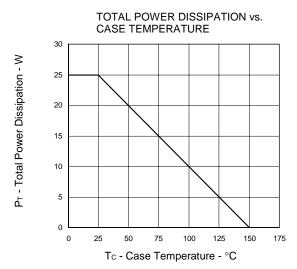


#### **TEST CIRCUIT 3 GATE CHARGE**

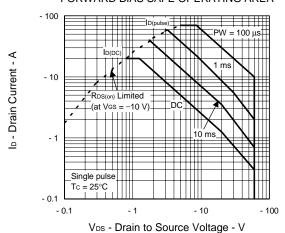


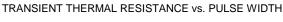
#### TYPICAL CHARACTERISTICS (TA = 25°C)

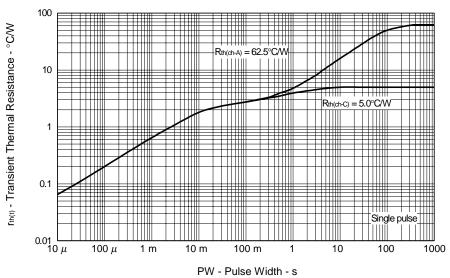




#### FORWARD BIAS SAFE OPERATING AREA

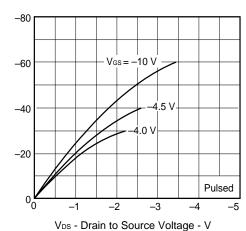




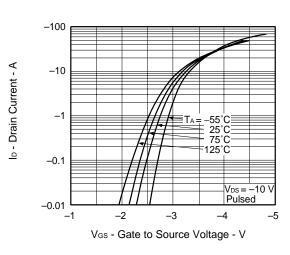


Ib - Drain Current - A

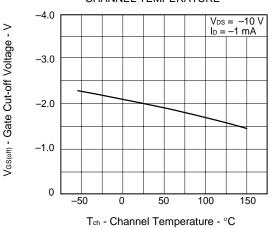
#### DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



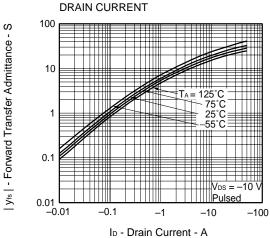
#### FORWARD TRANSFER CHARACTERISTICS



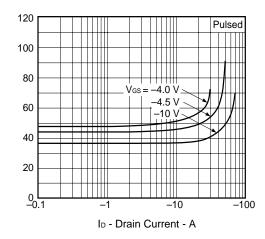
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



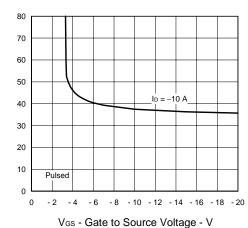
FORWARD TRANSFER ADMITTANCE vs.



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



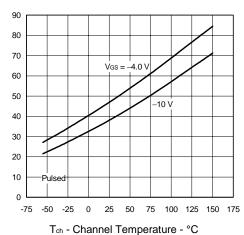
R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ

Res(m) - Drain to Source On-state Resistance - mΩ

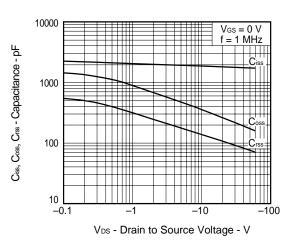
R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ

IF - Diode Forward Current - A

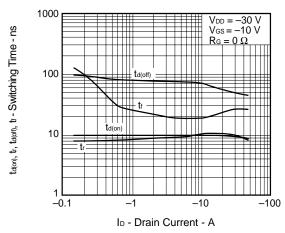
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



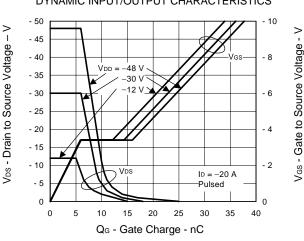
#### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



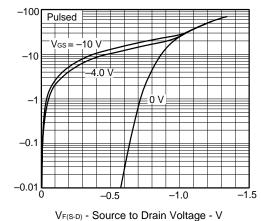
#### SWITCHING CHARACTERISTICS



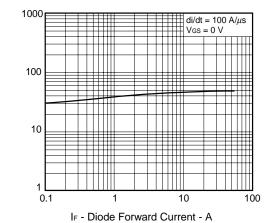
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



# SOURCE TO DRAIN DIODE FORWARD VOLTAGE



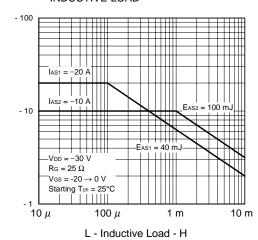
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



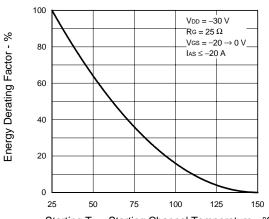
frr - Reverse Recovery Time - ns

I<sub>AS</sub> - Single Avalanche Current - A

## SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



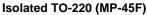
## SINGLE AVALANCHE ENERGY DERATING FACTOR

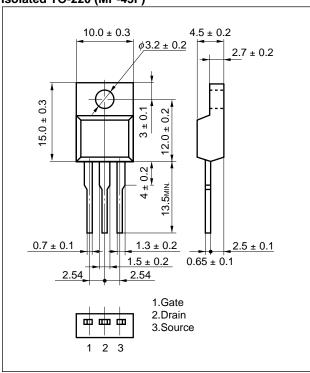


Starting  $T_{\text{ch}}$  - Starting Channel Temperature -  $^{\circ}C$ 

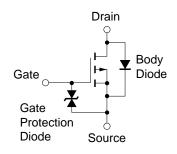


#### PACKAGE DRAWING (Unit: mm)





#### **EQUIVALENT CIRCUIT**



Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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